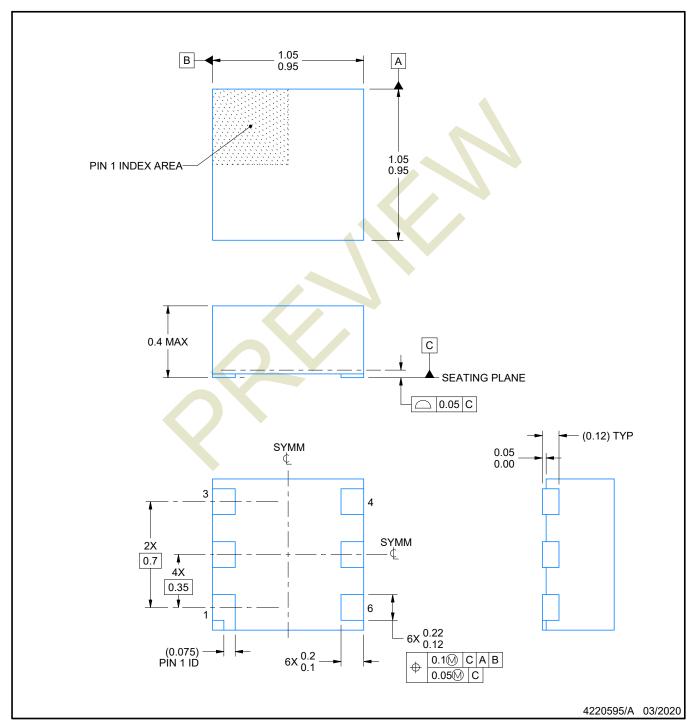


LEADFRAME EXAMPLE 6505430

DRAFTER:	ANIS FAUZI	DATE:	03/20/2020	DIMENSIONS IN MILLIMETERS				IETERS
DESIGNER:		DATE:				TEXAS INSTRUMENTS  CODE IDENTITY NUMBER		
CHECKER:	K. SINCERBOX	DATE:	03/30/2020			SEMICONDUCTOR OPERATIONS	C	1295
ENGINEER:	C. SINS	DATE:	03/20/2020			ePOD, DSF0006A / X2SON	١.	
APPROVED:	D. CHIN & E. LEE	DATE:	03/20/2020			6 PIN, 0.35 MM PITCH	-,	
RELEASED:	WDM	DATE:	03/20/2020			<u> </u>		
TEMPLATE IN	FO: EDGE# 4218519	DATE:	04/07/2016	NTS	A	4220595	A	PAGE 1 OF 5



PLASTIC SMALL OUTLINE - NO LEAD

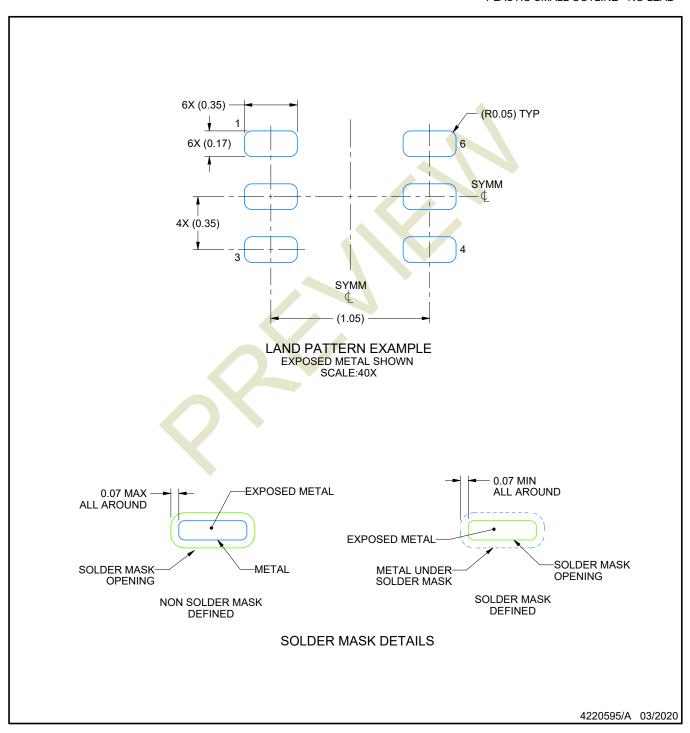


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC registration MO-287, variation X2AAF.



PLASTIC SMALL OUTLINE - NO LEAD

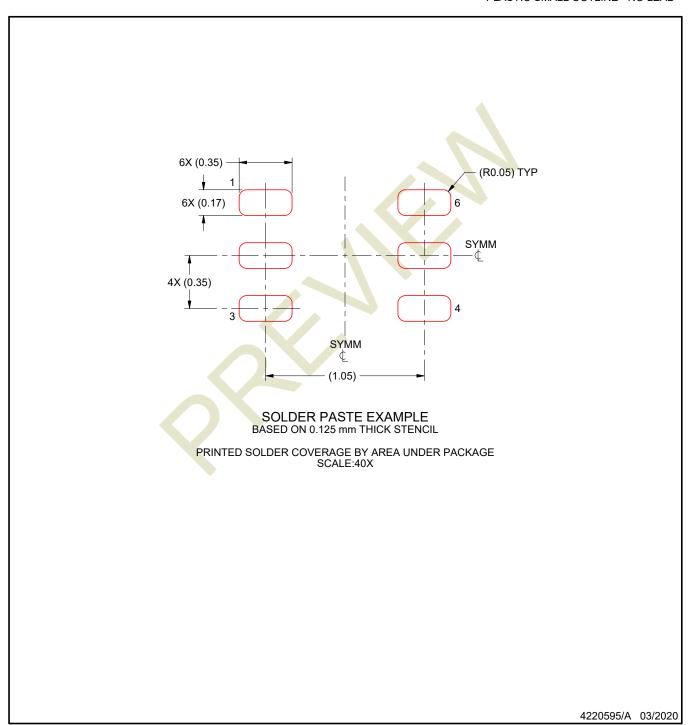


NOTES: (continued)

4. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).



PLASTIC SMALL OUTLINE - NO LEAD



4. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



